MOSFET - N-Channel, POWERTRENCH®

150 V, 169 A, 6.3 mΩ

特性

- 典型值 $r_{DS(on)}$ = 5 m Ω (在 V_{GS} = 10 V, I_D = 80 A)
- Typ $Q_{g(tot)} = 70 \text{ nC} \stackrel{?}{\leftarrow} V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS 能力
- This Device is Pb-Free and is RoHS Compliant

应用

- 工业电机驱动器
- 工业电源
- 工业自动化
- 电动工具
- 电池保护
- 太阳能逆变器
- UPS 和能源逆变器
- 储能
- 负载开关

最大额定值 (T」= 25°C, 除非另有说明)

符号	参数	额定值	单位
VDSS	漏极一源极电压	150	V
VGS	栅极一源极电压	±20	V
I _D	漏极电流一连续 (V _{GS} = 10 V) (注 1) T _C = 25°C	169	Α
	脉冲漏电流	见图 3	
EAS	单脉冲雪崩能量 (注 2)	502	mJ
P _D	功耗	500	W
	超过 25°C 时降额	3.3	W/°C
T_J , T_{STG}	工作和存储温度	-55 to +175	°C
$R_{ heta JC}$	结至壳体的热阻	0.3	°C/W
$R_{\theta JA}$	结至环境热阻最大值 (注 3)	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

(参考译文)

如果电压超过最大额定值表中列出的值范围,器件可能会损坏。如果超过任何这些限值,将无法保证器件功能,可能会导致器件损坏,影响可靠性。

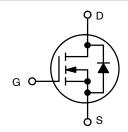
- 1. 电流受到结温的限制。
- 2. 电感充电期间,起始 T_J = 25°C, L = 0.24 mH, I_{AS} = 64 A, V_{DD} = 100 V, 雪崩时间内,V_{DD} = 100 V
- 3. $R_{0,D}$ 等于结至壳体和壳体至环境热阻之和,其中,壳体热参考定义为漏极引脚的焊料安装表面。 $R_{0,D}$ 具备设计保证,其中 $R_{0,D}$ 由用户的电路板设计确定。此处的最大额定值基于安装在 2 oz 铜的 1 in 2 焊盘上。



ON Semiconductor®

www.onsemi.cn

V _{DSS}	r _{DS(ON)} MAX	I _D MAX	
150 V	6.3 mΩ @ 10 V	169 A	



MOSFET - N-Channel



H-PSOF8L 11.68x9.80 CASE 100CU

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code

&3 = Date Code

&K = Lot Run Traceability Code FDBL0630N150 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

电气特性 (T_J = 25°C, 除非另有说明)

符号	参数	测试:	测试条件		典型值	最大值	单位
关断特性							
B _{VDSS}	漏极一源极击穿电压	$I_D = 250 \mu A, V_{GS} = 0 V$		150	-	_	V
I _{DSS}	漏极一源极漏电流	V _{DS} = 150 V, V _{GS} = 0 V	$T_J = 25^{\circ}C$	-	_	1	μΑ
			T _J = 175°C (注 4)	-	_	1	mA
I _{GSS}	栅极一源极漏电流	V _{GS} = ±20 V	V _{GS} = ±20 V		-	±100	nA
导通特性							
V _{GS(th)}	栅极至源极阀值电压	$V_{GS} = V_{DS}, I_D = 250 \mu A$		2.0	2.8	4.0	V
r _{DS(on)}	漏极至源极导通电阻	I _D = 80 A, V _{GS} = 10 V	$T_J = 25^{\circ}C$	-	5	6.3	mΩ
			T _J = 175°C (注 4)	-	14	17.5	mΩ
动态特性							
C _{iss}	输入电容	$V_{DS} = 75V, V_{GS} = 0V, f$	= 1 MHz	-	5805	-	pF
C _{oss}	输出电容		7		536	-	pF
C _{rss}	反向传输电容			-	16	-	pF
R_g	栅极阻抗	f = 1 MHz		-	2.2	-	Ω
Q _{g(ToT)}	在 10 V 的栅极总电荷	V _{GS} = 0 to 10 V, V _{DD} = 75 V, I _D = 80 A		-	70	90	nC
Q _{g(th)}	阀值栅极电荷	V _{GS} = 0 to 2 V, V _{DD} = 75 V, I _D = 80 A		-	10.5	13	nC
Q _{gs}	栅极一源极栅极电荷	V _{DD} = 75 V, I _D = 80 A		-	32.5	_	nC
Q_{gd}	栅极一漏极 "米勒" 电荷	V _{DD} = 75 V, I _D = 80 A	V _{DD} = 75 V, I _D = 80 A		10	_	nC
开关特性							
t _{on}	导通时间	$V_{DD} = 75 \text{ V}, I_D = 80 \text{ A}, V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		-	-	80	ns
t _{d(on)}	导通延迟时间			-	39	-	ns
t _r	上升时间			-	30	_	ns
t _{d(off)}	关断延迟时间			-	70	-	ns
t _f	下降时间			-	23		ns
t _{off}	关断时间			-	-	130	ns
属极一源极	公二极管特性						
V_{SD}	源极一漏极二极管电压	$I_{SD} = 80 \text{ A}, V_{GS} = 0 \text{ V}$		ı	_	1.25	V
		$I_{SD} = 40 \text{ A}, V_{GS} = 0 \text{ V}$			_	1.2	٧
T_{rr}	反向恢复时间	I _F = 80 A, dI _{SD} /dt = 100	A/μs, V _{DD} = 120 V	-	108	125	ns
Q _{rr}	反向恢复电荷			-	323	467	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. · (参考译文)

除非另有说明,"电气特性"表格中列出的是所列测试条件下的产品性能参数。如果在不同条件下运行,产品性能可能与"电气特性"表格 中所列性能参数不一致。
4. 其最大值根据 T_J = 175°C 时的设计确定。在生产中,未对此条件测试产品。

典型特性

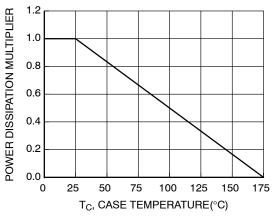


图1. 标准化功耗与壳体温度的关系

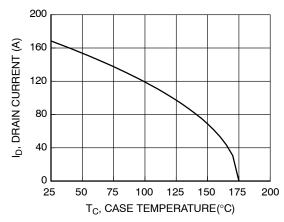


图2. 最大连续漏电流与壳体温度的关系

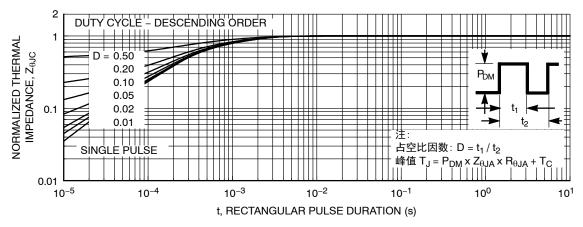


图3. 标准化最大瞬态热阻抗

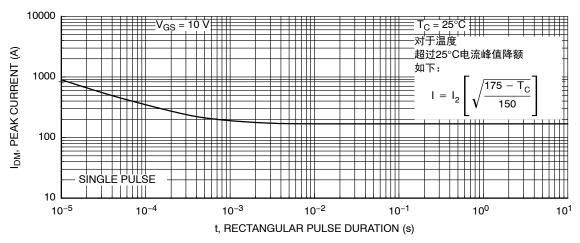


图4. 峰值电流能力

典型特性 (continued)

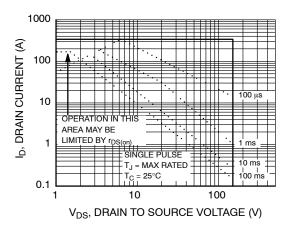
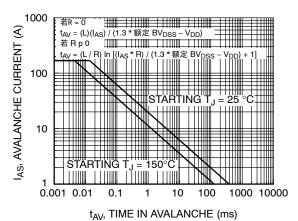


图5. 正向偏压安全工作区



注: 请参考 ON Semiconductor 应用指南 AN7514 和 AN7515

图6. 非箝位感性开关性能

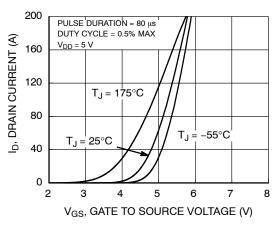


图7. 传递特性

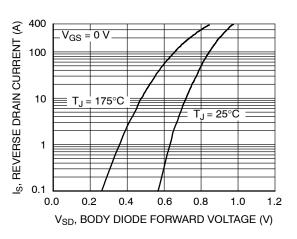


图8. 正向二极管特性

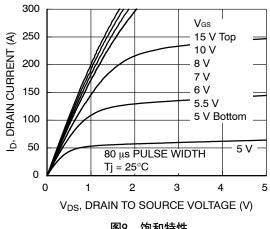


图9. 饱和特性

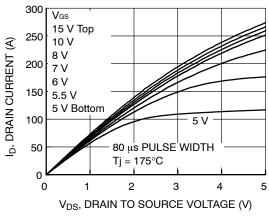


图10. 饱和特性

典型特性 (continued)

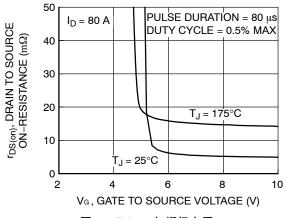


图11. Rdson与栅极电压

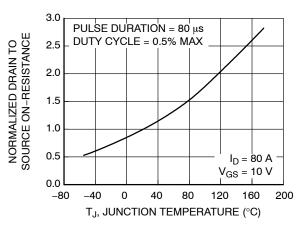


图12. 标准化Rdson与结温

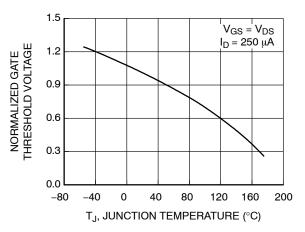


图13. 标准化栅极阀值电压与温度

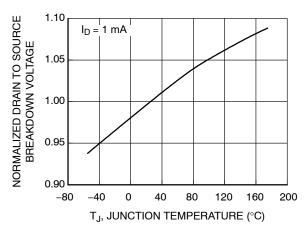


图14. 标准化漏极至源极击穿电压与结温

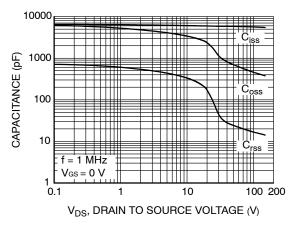


图15. 电容与漏极一源极电压

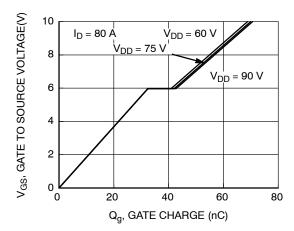


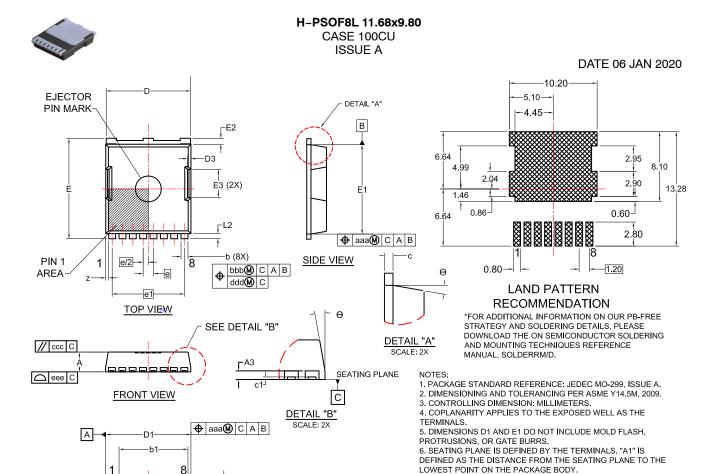
图16. 栅极电荷与栅极一源极电压

订购信息

器件	器件标识	封装	包装方法
FDBL0630N150	FDBL0630N150	H-PSOF8L 11.68x9.80 (Pb-Free)	2000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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DIM	MILLIMETERS			
5	MIN.	NOM.	MAX.	
Α	2.20	2.30	2.40	
A3	0.40	0.50	0.60	
b	0.70	0.80	0.90	
b1		8.00 REF	-	
С	0.40	0.50	0.60	
c1	0.10			
D	9.70	9.80	9.90	
D1	9.80	9.90	10.00	
D2	4.73 BSC			
D3	0.40 REF			
D4	3.75 BSC			
D5	_	1.20		
D6	7.40	7.50	7.60	
D7	(8.30)			
E	11.58	11.68	11.78	
E1	10.28	10.38	10.48	
E2	0.60	0.70	0.80	
E3	3.30 REF			

E4

DIM	MILLIMETERS			
Divi	MIN.	NOM.	MAX.	
е	1.20 BSC			
e/2	(0.60 BSC	;	
e1		3.40 BSC	;	
K	1.50	1.57	1.70	
L	1.90	2.00	2.10	
L2	0.50	0.60	0.70	
Z	0.35 REF			
θ	0°		12°	
aaa	0.20			
bbb	0.25			
ccc	0.20			
ddd	0.20			
eee	0.10			
E5	-	3.30	_	
E6		0.65	_	
E7	7.15 REF			
E8	6.55	6.65	6.75	
E9	5.89 BSC			
E10	5.19 BSC			

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

2.60

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DESCRIPTION:	H-PSOF8L 11.68x9.80		PAGE 1 OF 1	

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H.A.A.A.A.A.A

|--D5 (3X)

D4 -

-D7

BOTTOM VIEW

E10

E9

| E8

L

-0.10 E4 (2X)

E5 (2X) ⊢E6 (2X)

Α

WW

ZΖ

GENERIC
MARKING DIAGRAM*

AYWWZZ

XXXXXXXX

= Year

= Work Week

XXXX = Specific Device Code

= Assembly Location

= Assembly Lot Code

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